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August 2014

### **FDFS6N754**

# Integrated N-Channel PowerTrench<sup>®</sup> MOSFET and Schottky Diode 30V, 4A, $56m\Omega$

#### **Features**

- Max  $r_{DS(on)} = 56m\Omega$  at  $V_{GS} = 0V$ ,  $I_D = 4A$ Max  $r_{DS(on)} = 75m\Omega$  at  $V_{GS} = 4.5V$ ,  $I_D = 3.5A$
- V<sub>F</sub> < 0.45V @ 2A

V<sub>F</sub> < 0.28V @ 100mA

- Schottky and MOSFET incorporated into single power surface mount SO-8 package
- Electrically independent Schottky and MOSFET pinout for design flexibility
- Low Gate Charge (Qg = 4nC)
- Low Miller Charge



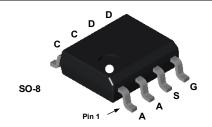
#### **General Description**

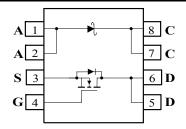
The FDFS6N754 combines the exceptional performance of Fairchild's PowerTrench MOSFET technology with a very low forward voltage drop Schottky barrier rectifier in an SO-8 package.

This device is designed specifically as a single package solution for DC to DC converters. It features a fast switching, low gate charge MOSFET with very low on-state resistance. The independently connected Schottky diode allows its use in a variety of DC/DC converter topologies.

#### **Applications**

■ DC/DC converters





#### **MOSFET Maximum Ratings** T<sub>A</sub> = 25°C unless otherwise noted

Symbol	Parameter		Ratings	Units
V <sub>DS</sub>	Drain to Source Voltage		30	V
V <sub>GS</sub>	Gate to Source Voltage		±20	V
I <sub>D</sub>	Drain Current -Continuous	(Note 1a)	4	А
	-Pulsed		20	^
P <sub>D</sub>	Power Dissipation for Dual Operation		2	w
	Power Dissipation for Single Operation	(Note 1a)	1.6	VV
$V_{RRM}$	Schottky Repetitive Peak Reverse Voltage		30	V
Io	Schottky Average Forward Current	(Note 1a)	2	Α
T <sub>.I</sub> , T <sub>STG</sub>	Operating and Storage Temperature		-55 to 150	°C

#### **Thermal Characteristics**

$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	(Note 1a)	78	°C/W
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	(Note 1)	40	°C/W

#### **Package Marking and Ordering Information**

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDFS6N754	FDFS6N754	SO-8	330mm	12mm	2500 units

Electrical Characteristics T <sub>J</sub> = 25°C unless otherwise noted								
Symbol	Parameter	Test Conditions	Min	Тур	Max	Units		
Off Char	acteristics							
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$	30			V		

BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0V$	30			V
$\frac{\Delta BV_{DSS}}{\Delta T_{J}}$	Breakdown Voltage Temperature Coefficient	$I_D$ = 250 $\mu$ A, referenced to 25°C		24.5		mV/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = 24V$ $V_{GS} = 0V$ $T_{J} = 125^{\circ}C$			1 20	μА
I <sub>GSS</sub>	Gate to Source Leakage Current	$V_{GS} = \pm 20V, V_{DS} = 0V$			±100	nA

#### On Characteristics (Note 2)

V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1	1.7	2.5	V	
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D$ = 250 $\mu$ A, referenced to 25°C		-4.2		mV/°C	
	Drain to Source On Resistance	$V_{GS} = 10V, I_D = 4A$		42	56	- mΩ	
rno( )		$V_{GS} = 4.5V, I_D = 3.5A$		53	75		
r <sub>DS(on)</sub>		$V_{GS} = 10V, I_D = 4A,$ $T_J = 125^{\circ}C$		61	81	11132	
g <sub>FS</sub>	Forward Transconductance	$V_{DS} = 5V$ , $I_D = 4A$		10		S	

#### **Dynamic Characteristics**

C <sub>iss</sub>	Input Capacitance	V 15V V 0V	225	299	pF
C <sub>oss</sub>	Output Capacitance	V <sub>DS</sub> = 15V, V <sub>GS</sub> = 0V, f = 1.0MHz	80	107	pF
C <sub>rss</sub>	Reverse Transfer Capacitance	1 - 1.0111112	42	63	pF
$R_{G}$	Gate Resistance	f = 1.0MHz	5.1		Ω

#### **Switching Characteristics** (Note 2)

t <sub>d(on)</sub>	Turn-On Delay Time		6	12	ns
t <sub>r</sub>	Rise Time	V <sub>DD</sub> = 15V, I <sub>D</sub> = 1A	8	16	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	$V_{GS} = 10V, R_{GS} = 6\Omega$	20	32	ns
t <sub>f</sub>	Fall Time		2	10	ns
$Q_{g(TOT)}$	Total Gate Charge at 10V	V <sub>DS</sub> = 15V,	4	6	nC
Q <sub>g(5)</sub>	Total Gate Charge at 5V	I <sub>D</sub> = 4A	2	3	nC
$Q_{gs}$	Gate to Source Gate Charge		0.6		nC
Q <sub>gd</sub>	Gate to Drain "Miller" Charge		1		nC

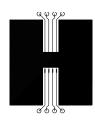
#### **Drain-Source Diode Characteristics and Maximum Ratings**

$V_{SD}$	Source to Drain Diode Forward Voltage	$V_{GS} = 0V, I_S = 1.3A$ (Note 2)	0.8	1.2	V
t <sub>rr</sub>	Reverse Recovery Time	$I_F = 4A$ , di/dt = 100A/ $\mu$ s	13	20	ns
$Q_{rr}$	Reverse Recovery Charge	I <sub>F</sub> = 4A, di/dt = 100A/μs	4	6	nC

#### **Schottky Diode Characteristics**

$V_R$	Reverse Breakdown Voltage	$I_R = -1mA$		-30			V
I <sub>R</sub>	Reverse Leakage	V <sub>R</sub> = -10V	$T_J = 25^{\circ}C$		39	250	μΑ
			$T_{J} = 125^{\circ}C$		18		mA
	Forward Voltage	I <sub>F</sub> = 100mA	$T_J = 25^{\circ}C$		225	280	
V			$T_{\rm J} = 125^{\rm o}{\rm C}$		140		mV
V <sub>F</sub>		I <sub>F</sub> = 2A	$T_J = 25^{\circ}C$		364	450	] '''V
			$T_{\rm J} = 125^{\rm o}{\rm C}$		290	·	

13 R<sub>0,IA</sub> is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R<sub>0,IC</sub> is guaranteed by design while R<sub>0CA</sub> is determined by the user's board design.



a) 78°C/W when mounted on a 0.5in<sup>2</sup> pad of 2 oz copper



ωψψω b) 125°C/W when mounted on a 0.02 in<sup>2</sup> pad of 2 oz copper



Q Ψ Ψ ν c) 135°C/W when mounted on a minimun pad



Scale 1: 1 on letter size paper

2: Pulse Test: Pulse Width < 300 µs, Duty Cycle < 2.0%.

#### Typical Characteristics T<sub>J</sub> = 25°C unless otherwise noted

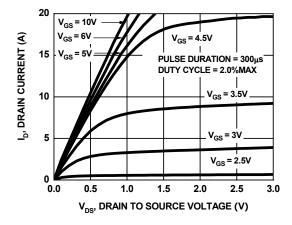


Figure 1. On Region Characteristics

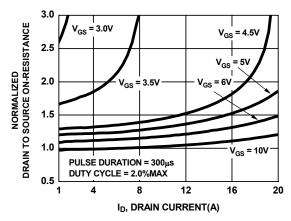


Figure 2. On-Resistance vs Drain Current and Gate Voltage

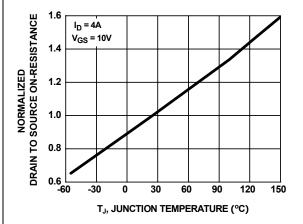


Figure 3. On Resistance vs Temperature

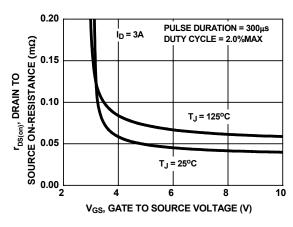


Figure 4. On-Resistance vs Gate to Source Voltage

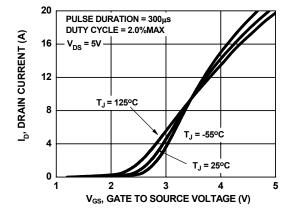


Figure 5. Transfer Characteristics

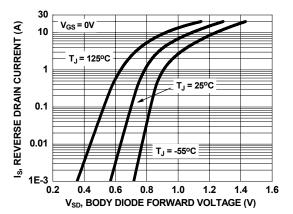


Figure 6. Source to Drain Diode Forward Voltage vs Source Current



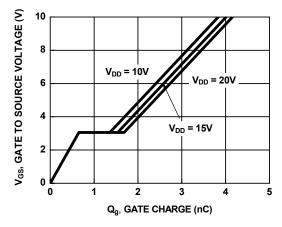


Figure 7. Gate Charge Characteristics

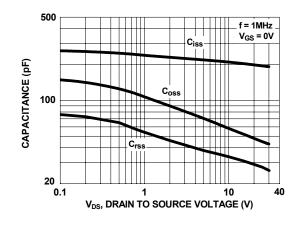


Figure 8. Capacitance vs Drain to Source Voltage

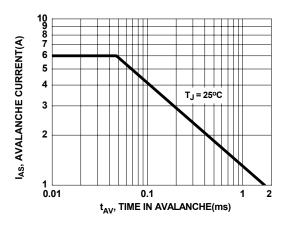


Figure 9. Unclamped Inductive Switching Capability

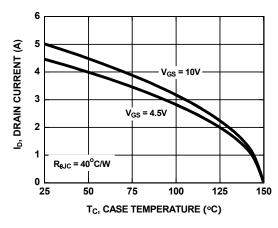


Figure 10. Maximum Continuous Drain Current vs
Case Temperature

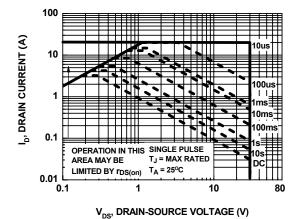


Figure 11. Forward Bias Safe Operating Area

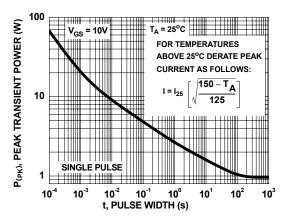
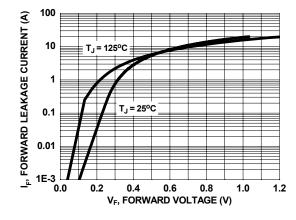


Figure 12. Single Pulse Maximum Power Dissipation





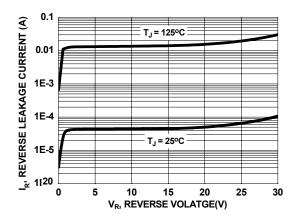


Figure 13. Schottky Diode Forward Voltage

Figure 14. Schottky Diode Reverse Current

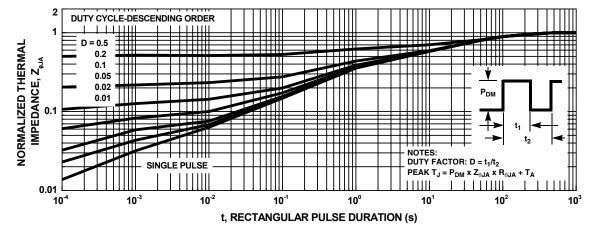
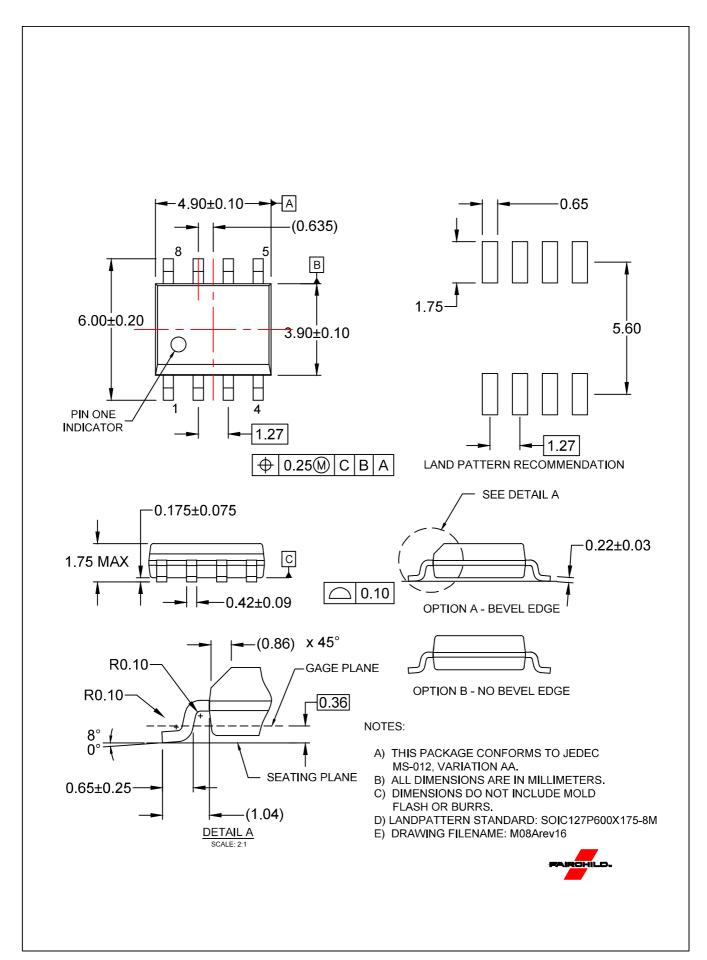


Figure 15. Transient Thermal Response Curve



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